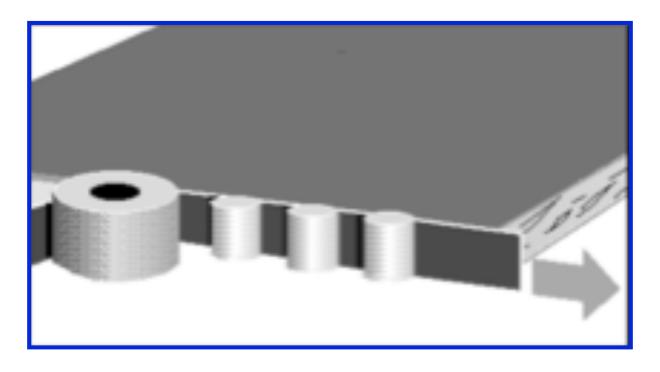
Edgebanding Technical Training



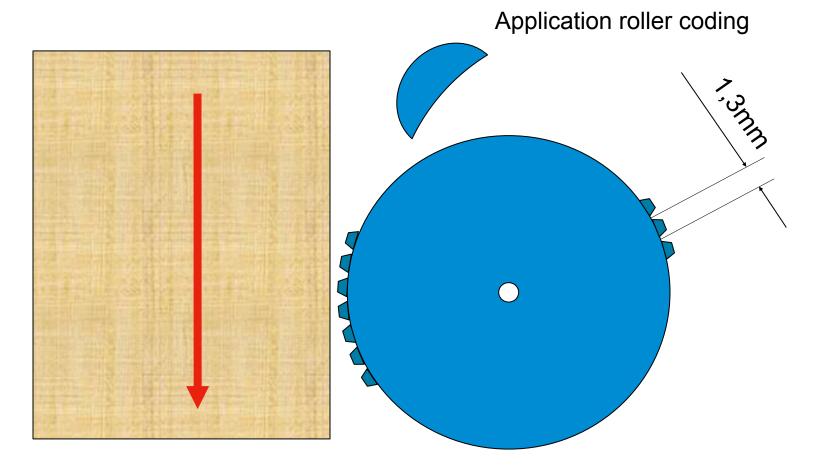


Roller Coater

Adhesive being applied to the edge of the board



Roller Coater - coding





Roller Coater – guide plate setting

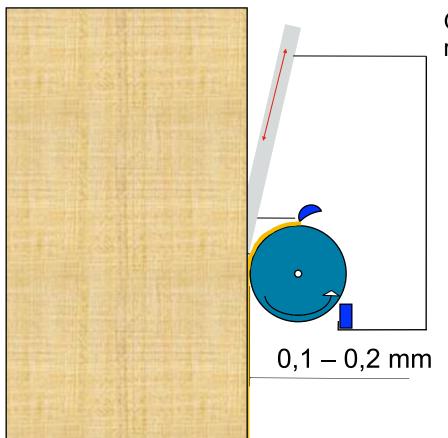
Set the guide plate so that the roller is 0,1 - 0,2mm from the board edge

Benefits:

- Even adhesive coating on the edging
- Improved adhesive wetting out on the edging
- Improved bond line
- Higher bond strength
- Reduced fibre contamination on the roller coater
- Reduced contamination in the glue pot
- Reduced damage to the board edge
- Increased heat resistance
- Increased water resistance



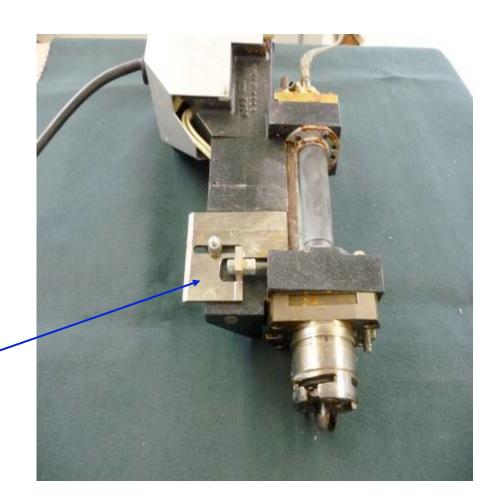
Roller Coater – guide plate setting



Guide plate setting on the application roller



Roller Coater – guide plate setting

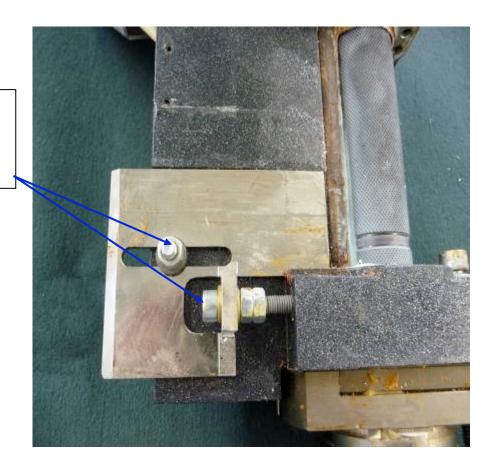


Guide Plate



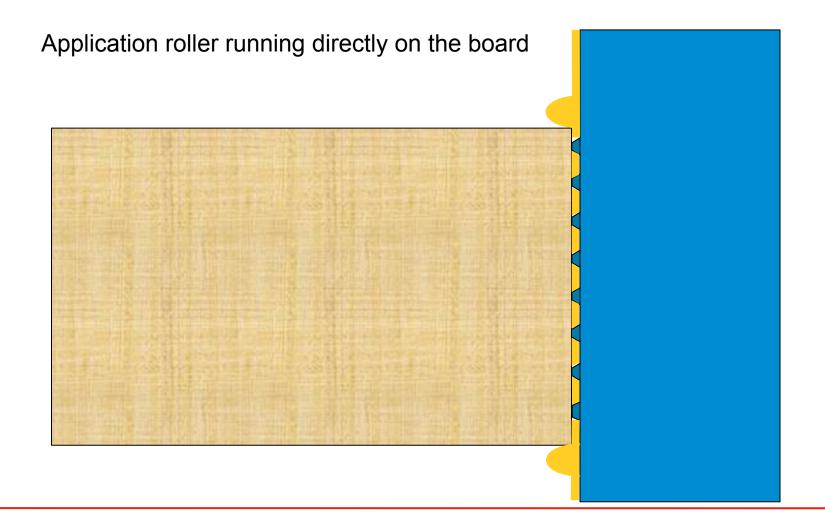
Roller Coater – guide plate setting

Guide plate adjustment screws





Roller Coater – guide plate setting





Roller Coater – guide plate setting



Roller coater set with direct contact to the board giving an uneven coating. (magnified x 40)

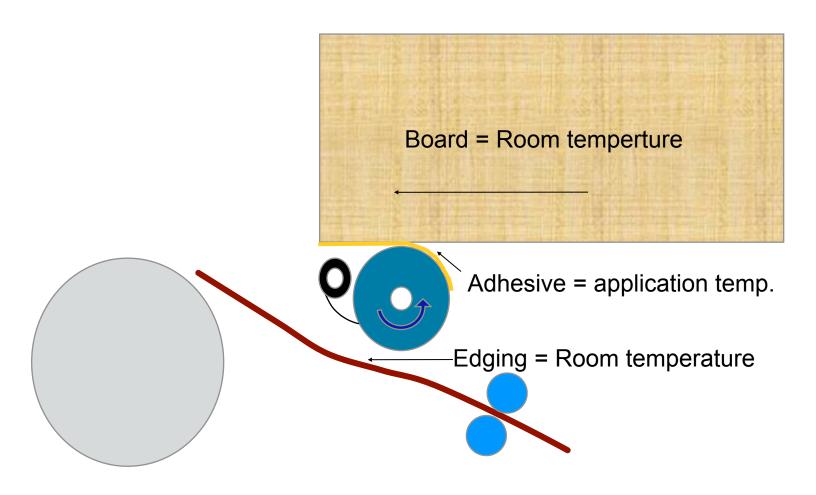


Roller Coater – guide plate setting

Application roller set correctly using the guide plate



Temperature control





Temperature control



Measure both panel and edge temperature



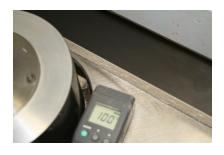
Temperature setting (melting equipment) in line with recommendation of hotmelt supplier (please check Technical Data Sheet)



Temperature control



Measure correct temperature on roller and compare it with figure shown on display. Adjust if required.



Measure adhesive temperature (contact) on the board before the edging is applied.



Edge BandingPressure roller



Check correct pressure on display.



Additionally, check correct pressure directly on roller.



Pressure roller - settings

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- Thin edging
- Thick edging
- Solid Wood

Main Pressure Roller Small Pressure Roller

2.5 bar

3 bar

3 bis 4 bar

3 bar

< 1 bar

3 bar



Edge BandingGeneral Information

Store adhesive in a dry, and and dust free environment.

Set the correct application temperature of the adhesive

Adhesive application weight has to be set correctly, with an even coating across the edge, and with the correct guide plate setting.

Set the pressure roller to the correct setting according the edging being run.

Ensure the edge preparation of the board is a 90 degrees

Both board and edge temperature have a minimum of 18 °C

Ensure correct extraction around the roller coater

Avoid dust contamination in the area of adhesive application



Fault Finding





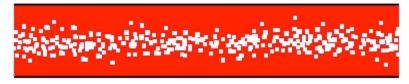
Transparent edge fault finding

Smooth hotmelt coating above, no hotmelt below or vice versa



Panel not right angled.

Open pores in middle layer of panel



Hotmelt amount too low

Smooth hotmelt coating

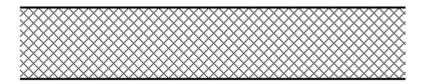


Hotmelt application ok



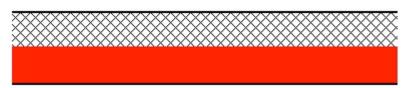
Transparent edge fault finding

Hotmelt shows pattern of roller



Hotmelt too cold or Chipboard too cold or the pressure roller set too low

Pattern of roller above, smooth hotmelt coating below, or vice versa



Chipboard not correctly angled or the pressure roller not correctly angled



Thank You

